

## Informacije o proizvodu (EN)

HP laptop 240 G8 (2X7J3EA)



Tehnoteka je online destinacija za upoređivanje cena i karakteristika bele tehnike, potrošačke elektronike i IT uređaja kod trgovinskih lanaca i internet prodavnica u Srbiji. Naša stranica vam omogućava da istražite najnovije informacije, detaljne karakteristike i konkurentne cene proizvoda.

Posetite nas i uživajte u ekskluzivnom iskustvu pametne kupovine klikom na link:

<https://tehnoteka.rs/p/hp-laptop-240-g8-2x7j3ea-akcija-cena/>

### Overview

#### HP 240 G8 Notebook PC



#### Left

- |                                |   |
|--------------------------------|---|
| 1. Webcam LED                  | 7. Hard drive indicator LED   |
| 2. Webcam                      | 8. SD Card slot (Select models)   |
| 3. Internal digital microphone | 9. SuperSpeed USB Type-C® 5Gbps signaling rate <sup>1</sup> port (Data Transfer Only) |
| 4. Touchpad                    | 10. Mini Security lock slot (Lock sold in select countries)                           |
| 5. Touchpad buttons            | 11. Power button  |
| 6. Power indicator LED         |   |

1. SuperSpeed USB 20Gbps is not available.

### Overview



#### Right

1. AC Smart Pin adapter plug
2. RJ-45 / Ethernet port
3. HDMI port (Cable not included)
4. SuperSpeed USB Type-A 5Gbps signaling rate<sup>1</sup> port (USB 3.2 Gen 1)
5. SuperSpeed USB Type-A 5Gbps signaling rate<sup>1</sup> port (USB 3.2 Gen 1)
6. Audio combo jack

1. SuperSpeed USB 20Gbps is not available.

### Overview

#### At a Glance

- Windows 11 Pro, other Windows OS, or FreeDOS preinstalled
- A new compact narrow bezel design with thinner & lighter chassis
- Choice of 11th or 10th Generation Intel® Core™ i7, i5 and i3 processors and Intel® Pentium®, or Intel® Celeron® processors
- Choice of 35.56 cm (14") diagonal HD Anti-Glare WLED SVA or FHD Anti-Glare WLED IPS
- Optional NVIDIA GeForce MX450 discrete graphics with 2 GB GDDR5 video memory or AMD Radeon™ 620
- Security features including Firmware TPM 2.0
- Weight starting at 3.25 lbs (1.47 kgs)
- MM18 Battery life up to 10 hours <sup>1</sup>
- Wireless LAN (WLAN) up to 802.11ac or 802.11ax to keep you connected
- One SuperSpeed USB Type-C® 5Gbps signaling rate <sup>2</sup> (Data Transfer Only), Two SuperSpeed USB Type-A 5Gbps signaling rate <sup>2</sup>
- Choice of Solid State Drives up to 1 TB and Hard Drive up to 1 TB
- Fast dual channel DDR4 SODIMM memory up to 16 GB
- HP webcam with digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera
- GML-R 6W CPU offers fanless design with cooling fin<sup>3</sup>

1. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

2. SuperSpeed USB 20Gbps is not available.

3. Other CPU are still equipped with the cooling fan.

**NOTE:** See important legal disclosures for all listed specs in their respective feature sections.



## Technical Specifications

### PRODUCT NAME

HP 240 G8 Notebook PC

### OPERATING SYSTEMS

#### Preinstalled

Windows 11 Pro <sup>2</sup>  
Windows 11 Pro Education <sup>2</sup>  
Windows 11 Home – HP recommends Windows 11 Pro for business<sup>2</sup>  
Windows 11 Home Single Language - HP recommends Windows 11 Pro for business<sup>2</sup>  
Windows 10 Pro <sup>1,2</sup>  
Windows 10 Pro Education <sup>1,2</sup>  
Windows 10 Home - HP recommends Windows 11 Pro for business <sup>1,2</sup>  
Windows 10 Home Single Language - HP recommends Windows 11 Pro for business<sup>1,2</sup>  
FreeDOS

1. Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

2. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

### PROCESSORS

Intel® Core™ i7-1065G7 (1.3 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Core™ i5-1035G1 processor with Intel® UHD Graphics (1.0 GHz base frequency, up to 3.6 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Core™ i5-10210U Processor with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Core™ i3-1005G1 processor with Intel® UHD Graphics (1.2 GHz base frequency, up to 3.4GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores) <sup>3,4,5,6</sup>  
Intel® Pentium® Silver N5030 Processor with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 3.1 GHz burst frequency, 4 MB cache, 4 cores) <sup>3,4,6</sup>  
Intel® Celeron® N4020 Processor with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.8 GHz burst frequency, 4 MB cache, 2 cores) <sup>3,4,6</sup>  
Intel® Core™ i7-1165G7 processor (2.8 GHz base frequency, up to 4.7 GHz frequency with Intel® Turbo Boost Technology, 12MB cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Core™ i5-1135G7 processor (2.4 GHz base frequency, up to 4.2 GHz frequency with Intel® Turbo Boost Technology, 8MB cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Core™ i3-1115G4 processor with Intel® UHD Graphics (3.0 GHz base frequency, up to 4.1 GHz frequency with Intel® Turbo Boost Technology, 6 MB cache, 2 cores) <sup>3,4,5,6</sup>  
Intel Core™ i3-1125G4 processor with Intel® UHD Graphics (2.0 GHz base frequency, up to 3.7 GHz frequency with Intel® Turbo Boost Technology, 8 MB cache, 4 cores) <sup>3,4,5,6</sup>  
Intel® Celeron® 6305 Processor with Intel® UHD Graphics (1.8 GHz base frequency, 4 MB cache, 2 cores) <sup>3,4,6</sup>

#### Processors Family

11th/10th Generation Intel® Core™ i7 processor <sup>6</sup>  
11th/10th Generation Intel® Core™ i5 processor <sup>6</sup>  
11th/10th Generation Intel® Core™ i3 processor <sup>6</sup>



### Technical Specifications

Intel® Pentium® Silver Processor <sup>6</sup>  
Intel® Celeron® processor <sup>6</sup>

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.
6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

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### CHIPSET

Chipset is integrated with processor

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### GRAPHICS

#### Integrated

Intel® Iris® Xe Graphics<sup>30</sup>  
Intel® Iris® Plus Graphics<sup>30</sup>  
Intel® UHD Graphics  
Intel® UHD Graphics 605  
Intel® UHD Graphics 600

#### Discrete

AMD Radeon™ 620 (2 GB GDDR5 dedicated) <sup>8</sup>  
NVIDIA® GeForce® MX450 (2 GB DDR5 dedicated) <sup>8</sup>

#### Supports

Support HD decode, DX12, HDMI 1.4b <sup>7</sup>

7. HD content required to view HD images.
8. AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD Radeon™ discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).
30. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or i7 processors and single channel memory will only function as UHD graphics.



## Technical Specifications

### DISPLAYS

#### Internal

##### Non-Touch

35.56 cm (14") diagonal, HD (1366 x 768), SVA, Anti-Glare WLED, 250nits, eDP micro-edge, 45% NTSC <sup>7,9,10</sup>  
35.56 cm (14") diagonal, FHD (1920 x 1080), IPS, Anti-Glare WLED, 250nits eDP micro-edge, 45% NTSC <sup>7,9,10</sup>

##### HDMI

Port supports resolutions up to 1920 x 1080 external resolution @60 Hz

7. HD content required to view HD images.

9. Sold separately or as an optional feature.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

### STORAGE AND DRIVES

#### Primary Storage

1 TB 5400 rpm SATA <sup>11</sup>

500 GB 7200 rpm SATA <sup>11</sup>

500 GB 5400 rpm SATA <sup>11</sup>

#### Primary M.2 Storage

128 GB M.2 SATA-3 TLC Solid State Drive <sup>11</sup>

256 GB M.2 SATA-3 TLC Solid State Drive <sup>11</sup>

256 GB PCIe® NVMe™ M.2 QLC Solid State Drive <sup>11</sup>

512 GB PCIe® NVMe™ M.2 QLC Solid State Drive <sup>11</sup>

1 TB PCIe® NVMe™ M.2 QLC Solid State Drive <sup>11</sup>

256 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 16 GB Intel® Optane™ memory H10 <sup>11,12,13</sup>

512 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10 <sup>11,12,13</sup>

64 GB eMMC <sup>11</sup>

#### Dual Storage <sup>35</sup>

128 GB M.2 SATA-3 TLC Solid State Drive + 1TB 5400rpm SATA <sup>11</sup>

256 GB PCIe® NVMe™ M.2 QLC Solid State Drive + 1TB 5400rpm SATA <sup>11</sup>

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

12. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

13. Intel® Optane™ memory H10 only for Intel® PCIe® NVMe™ QLC M.2 SSD.

35. GML-R don't support dual storage due to design limitation.



### Technical Specifications

#### MEMORY

##### Maximum Memory

16 GB DDR4-3200 SDRAM<sup>14</sup>

##### Memory

16 GB DDR4-3200 SDRAM (2 x 8 GB) <sup>14</sup>

16 GB DDR4-2666 SDRAM (2 x 8 GB) <sup>14</sup>

12 GB DDR4-3200 SDRAM (4 GB (1 x 4 GB) and 8 GB (1 x 8 GB))<sup>14</sup>

12 GB DDR4-2666 SDRAM (4 GB (1 x 4 GB) and 8 GB (1 x 8 GB))<sup>14</sup>

8 GB DDR4-3200 SDRAM (1 x 8 GB) <sup>14</sup>

8 GB DDR4-2666 SDRAM (1 x 8 GB) <sup>14</sup>

8 GB DDR4-2400 SDRAM (1 x 8 GB) <sup>14</sup>

8 GB DDR4-3200 SDRAM (2x 4 GB) <sup>14</sup>

8 GB DDR4-2666 SDRAM (2 x 4 GB) <sup>14</sup>

4 GB DDR4-3200 SDRAM (1 x 4 GB) <sup>14</sup>

4 GB DDR4-2666 SDRAM (1 x 4 GB) <sup>14</sup>

4 GB DDR4-2400 SDRAM (1 x 4 GB) <sup>14</sup>

##### Memory Slots

DDR4 SODIMMS, system runs at 2666 <sup>34</sup>

2 SODIMM (Intel 10<sup>th</sup> & 11<sup>th</sup> Generation Intel Core processor) (Core i 3/5/7 speed runs up to 2666)

Supports Dual Channel Memory

1 SODIMM (Intel Pentium/Celeron speed runs up to 2400)

Support Single Channel Memory

**NOTE:** All slots are customer non-accessible / non-upgradeable

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

34. DDR4 3200 bridges to DDR4 2666.



### Technical Specifications

#### NETWORKING/COMMUNICATIONS

##### WLAN

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 5.0 Wireless Card <sup>33</sup>

Realtek RTL8822CE 802.11a/b/g/n/ac (1x1) Wi-Fi® with Bluetooth® 5.0 Wireless Card <sup>33</sup>

Intel® Dual Band Wi-Fi 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5.2 Wireless Card, non-vPro® <sup>15</sup>

##### Miracast

Compatible with Miracast-certified devices (For Win10) <sup>16</sup>

##### Ethernet

Realtek 10/100/1000 GbE NIC <sup>17</sup>

15. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

17. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

33. Wi-Fi supporting gigabit speeds (802.11ac) is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.

#### AUDIO/MULTIMEDIA

##### Audio

2 Integrated stereo speakers

Integrated digital microphone

##### Camera

HP TrueVision HD Camera <sup>7,9</sup>

##### Webcam

VGA webcam <sup>9</sup>

7. HD content required to view HD images.

9. Sold separately or as an optional feature.



### Technical Specifications

#### KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

##### Keyboard

Full Size Textured island-style Keyboard

##### Pointing Device

Touchpad with multi-touch gesture support (PTP certified)

##### Function Keys

F1 - Open " How to get help in Windows 10" webpage

F2 - Brightness Down

F3 - Brightness Up

F4 - Display Switching

F5 - Blank

F6 - Mute

F7 - Volume Down

F8 -Volume Up

F9 - Previous

F10 - Play/Pause

F11 - Next

F12 - Airplane mode

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#### SOFTWARE AND SECURITY

##### Preinstalled Software

###### Software

McAfee LiveSafe™<sup>18</sup>

HP Support Assistant<sup>19</sup>

Native Miracast Support<sup>20</sup>

HP documentation

HP Setup Integrated OOBE

HP SSRM

HP Audio Switch

HP JumpStarts

Xerox® DocuShare® 30 day free trial offer<sup>29</sup>

HP QuickDrop

HP Smart Support<sup>31</sup>

##### Security Management

Firmware TPM 2.0<sup>21</sup>

18. 30 days free trial.

19. HP Support Assistant requires Windows and Internet access.

20. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

21. Firmware TPM is version 2.0, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).<sup>32</sup> Firmware TPM is version 2.0.

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## Technical Specifications

31. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: <http://www.hp.com/smart-support>. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

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### POWER

#### Power Supply

HP Smart 65 W External AC power adapter <sup>22</sup>

HP Smart 65 W EM External AC power adapter <sup>22</sup>

HP Smart 45 W External AC power adapter <sup>22</sup>

#### Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion Polymer<sup>23, 32</sup>

HP Long Life 4-cell, 46 Wh Li-ion Battery Polymer (India only) <sup>23, 32</sup>

#### Power Cord

1M (3.28 feet) length power cord

#### MM18 Battery life

Up to 10 hours <sup>24</sup>

#### Battery Weight

0.18 kg

0.39 lb

22. Availability may vary by country.

23. Battery is internal and not replaceable by customer. Serviceable by warranty.

24. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

32. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

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### Technical Specifications

#### WEIGHTS & DIMENSIONS

**Product Weight** <sup>25</sup>

Starting at 3.25 lb

Starting at 1.47 kg

**Product Dimensions (w x d x h)**

12.76 x 8.89 x 0.78 in

32.4 x 22.59 x 1.99 cm

25. Weight will vary by configuration.

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#### PORTS/SLOTS

**Ports**

2 SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1)<sup>26</sup>

1 SuperSpeed USB Type-C<sup>®</sup> 5Gbps signaling rate<sup>26</sup> (Supports data transfer only and does not support charging or external monitors)

1 HDMI v1.4b <sup>26</sup>

1 RJ-45

1 AC Power

1 Headphone/microphone combo jack

**Expansion Slots**

Support SD/SDHC/SDXC

1 Multi-format digital media reader (Select models)

26. SuperSpeed USB 20Gbps is not available.

27. HDMI cable sold separately.

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### Technical Specifications

#### SERVICE AND SUPPORT

1-year limited warranty and 90-day software limited warranty options depending on country. Batteries have a default one-year limited warranty. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.<sup>28</sup>

28. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

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## Technical Specifications

### SYSTEM UNIT

#### Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage	19.5 V
Average Operating Power	TBD
Integrated graphics	6.37W
Discrete Graphics	N/A (Switchable graphics design)
Max Operating Power	Discrete < 65W UMA < 45W

#### Temperature

Operating	32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)
Non-operating	-4° to 140° F (-20° to 60° C)

#### Relative Humidity

Operating	10% to 90%, non-condensing
Non-operating	5% to 95%

#### Shock

Operating	40 G, 2 ms, half-sine
Non-operating	240 G, 2 ms, half-sine

#### Random Vibration

Operating	1.043 grms
Non-operating	3.5 grms

#### Altitude (unpressurized)

Operating	-15 m to 3048 m (-50 ft to 10000 ft)
Non-operating	-15 m to 12192 m (-50 ft to 40000 ft)

#### Planned Industry Standard

##### Certifications

UL	Yes
CSA	No
FCC Compliance	Yes
ENERGY STAR®	Yes
EPEAT®	Yes
ICES	Yes
Australia /	No
NZ A – Tick Compliance	No
CCC	Yes
Japan VCCI Compliance	Yes
KC	No
BSMI	Yes
CE Marketing Compliance	Yes
BNCI or BELUS	No
CIT	No
GOST	No
Saudi Arabian Compliance (ICCP)	No



## Technical Specifications

SABS	No
UKRSERTCOMPUTER	No

### DISPLAYS

**NOTE:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

<b>Panel LCD 14-in FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP NWBZ slim</b>	<b>Outline Dimensions (W x H x D)</b>	316.11 x 198.07 max. (w/ PCB)(mm)
	<b>Active Area</b>	309.31 x 173.99(mm)
	<b>Weight</b>	285g max.
	<b>Diagonal Size</b>	14.0"
	<b>Thickness</b>	3.0mm max.
	<b>Interface</b>	eDP 1.2
	<b>Surface Treatment</b>	Anti-glare (AG)
	<b>Touch Enabled</b>	None
	<b>Contrast Ratio</b>	600:1 (typ)
	<b>Refresh Rate</b>	60Hz
	<b>Brightness</b>	250nit typ.
	<b>Pixel Resolution</b>	1920 x 1080 (FHD)
	<b>Format</b>	RGB
	<b>Backlight</b>	LED
	<b>Color Gamut Coverage</b>	45%
	<b>Color Depth</b>	6bit
	<b>Viewing Angle</b>	UWVA 85/85/85/85

<b>Panel LCD 14.0 HD AG WLED SVA 45%cg 220nits eDP Slim</b>	<b>Outline Dimensions (W x H x D)</b>	320.9x205.6 (max)
	<b>Active Area</b>	309.4 x 173.95
	<b>Weight</b>	280 max.
	<b>Diagonal Size</b>	14.0"
	<b>Thickness</b>	3.0mm max
	<b>Interface</b>	VESA with EDID V3.1
	<b>Surface Treatment</b>	Anti-glare (AG)
	<b>Touch Enabled</b>	None
	<b>Contrast Ratio</b>	300:1 (typ)
	<b>Refresh Rate</b>	60Hz
	<b>Brightness</b>	220 nit typ
	<b>Pixel Resolution</b>	1366 x 768 (HD)
	<b>Format</b>	RGB
	<b>Backlight</b>	LED
	<b>Color Gamut Coverage</b>	45%
	<b>Color Depth</b>	6 bits
	<b>Viewing Angle</b>	SVA 40/40/15/30



### Technical Specifications

#### STORAGE AND DRIVES\*

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

<b>SSD 128GB 2280 M2 SATA-3 TLC (SSD 128GB 2280 M2 SATA-3 TLC)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	128 GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	ATA-8, SATA 3.0
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up To 560 MB/s
	<b>Maximum Sequential Write</b>	Up To 530 MB/s
	<b>Logical Blocks</b>	250,069,680
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]

<b>SSD 1TB 2280 PCIe NVMe QLC (SSD 1TB 2280 PCIe NVMe QLC)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	1 TB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X4
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 2400MB/s
	<b>Maximum Sequential Write</b>	Up to 1950MB/s
	<b>Logical Blocks</b>	2,000,409,264
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]

<b>SSD 256GB 2280 M2 SATA-3 TLC (SSD 256GB 2280 M2 SATA-3 Three Layer Cell)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	256 GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X4
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 530MB/s
	<b>Maximum Sequential Write</b>	Up to 520MB/s
	<b>Logical Blocks</b>	500,118,192
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]

<b>SSD 256GB 2280 PCIe NVMe QLC (SSD 256GB 2280 PCIe NVMe QLC)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	256GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X2
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 1500MB/s



## Technical Specifications

<b>Maximum Sequential Write Logical Blocks</b>	Up to 750MB/s
<b>Operating Temperature</b>	500,118,192
<b>Features</b>	32° to 158°F (0° to 70°C) [ambient temp]
	TRIM, L1.2

<b>SSD 512GB 2280 PCIe NVMe QLC (SSD 512GB 2280 PCIe NVMe QLC)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	512GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X2
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 1500MB/s
	<b>Maximum Sequential Write</b>	Up to 750MB/s
	<b>Logical Blocks</b>	1,000,215,216
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]
<b>Features</b>	TRIM, L1.2	

<b>SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint (SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	16 GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X2
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 900MB/s
	<b>Maximum Sequential Write</b>	Up to 145MB/s
	<b>Logical Blocks</b>	28,181,188
<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]	



### Technical Specifications

<b>SSD 256GB 2280 PCIe-3x2x2 NVMe+SSD 16GB 3D Xpoint (SSD 256GB 2280 PCIe-3x2x2 NVMe +SSD 16GB 3D Xpoint)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	256 GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X2X2
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 1450MB/s
	<b>Maximum Sequential Write</b>	Up to 500MB/s
	<b>Logical Blocks</b>	500,118,192
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]

<b>SSD 512GB 2280 PCIe-3x2x2 NVMe+SSD 32GB 3D Xpoint (SSD 512GB 2280 PCIe-3x2x2 NVMe +SSD 32GB 3D Xpoint)</b>	<b>Drive Weight</b>	0.01 lb (6 g) ~ 0.02 lb (10 g)
	<b>Capacity</b>	512 GB
	<b>Height</b>	0.09 in (2.3 mm)
	<b>Width</b>	0.87 in (22 mm)
	<b>Interface</b>	PCIe NVMe Gen3X2X2
	<b>Performance</b>	
	<b>Maximum Sequential Read</b>	Up to 2400MB/s
	<b>Maximum Sequential Write</b>	Up to 1300MB/s
	<b>Logical Blocks</b>	1,000,215,215
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambient temp]

### Technical Specifications

#### NETWORKING/COMMUNICATIONS

<p><b>Intel® Wi-Fi 6 AX201 + Bluetooth® 5.2 Wireless Card (802.11ax 2x2, non-vPro®, supporting gigabit file transfer speeds) non-vPro®<sup>1,2</sup></b></p>	<p><b>Wireless LAN Standards</b></p> <ul style="list-style-type: none"> <li>IEEE 802.11a</li> <li>IEEE 802.11b</li> <li>IEEE 802.11g</li> <li>IEEE 802.11n</li> <li>IEEE 802.11ac</li> <li>IEEE 802.11ax</li> <li>IEEE 802.11d</li> <li>IEEE 802.11e</li> <li>IEEE 802.11h</li> <li>IEEE 802.11i</li> <li>IEEE 802.11k</li> <li>IEEE 802.11r</li> <li>IEEE 802.11v</li> </ul>
<p><b>Interoperability</b></p>	<p>Features Wi-Fi® 6 technology</p>
<p><b>Frequency Band</b></p>	<ul style="list-style-type: none"> <li>• 802.11b/g/n/ax 2.402 – 2.482 GHz</li> <li>• 802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.47 – 5.725 GHz</li> <li>5.825 – 5.850 GHz</li> </ul>
<p><b>Data Rates</b></p>	<ul style="list-style-type: none"> <li>• 802.11b: 1, 2, 5.5, 11 Mbps</li> <li>• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)</li> <li>• 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &amp; 160MHz)</li> </ul>
<p><b>Modulation</b></p>	<p>Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM</p>
<p><b>Security<sup>3</sup></b></p>	<ul style="list-style-type: none"> <li>• IEEE compliant 64 /128 bit WEP encryption for a/b/g mode only</li> <li>• AES-CCMP: 128 bit in hardware</li> <li>• 802.1x authentication</li> <li>• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>• WPA2 certification</li> <li>• IEEE 802.11i</li> <li>• WAPI</li> </ul>
<p><b>Network Architecture Models</b></p>	<p>Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)</p>
<p><b>Roaming</b></p>	<p>IEEE 802.11 compliant roaming between access points</p>
<p><b>Output Power<sup>4</sup></b></p>	<ul style="list-style-type: none"> <li>• 802.11b: +18.5dBm minimum</li> <li>• 802.11g: +17.5dBm minimum</li> <li>• 802.11a: +18.5dBm minimum</li> <li>• 802.11n HT20(2.4GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(2.4GHz): +14.5dBm minimum</li> <li>• 802.11n HT20(5GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(5GHz): +14.5dBm minimum</li> <li>• 802.11ac VHT80(5GHz): +11.5dBm minimum</li> <li>• 802.11ac VHT160(5GHz): +11.5dBm minimum</li> <li>• 802.11ax HT40(2.4GHz): +10dBm minimum</li> </ul>



### Technical Specifications

<b>Power Consumption</b>	<ul style="list-style-type: none"> <li>• 802.11ax VHT160(5GHz): +10dBm minimum</li> <li>• Transmit mode: 2.0 W</li> <li>• Receive mode: 1.6 W</li> <li>• Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>• Idle mode: 50 mW (WLAN unassociated)</li> <li>• Connected Standby/Modern Standby: 10mW</li> <li>• Radio disabled: 8 mW</li> </ul>
<b>Power Management</b>	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
<b>Receiver Sensitivity<sup>5</sup></b>	<ul style="list-style-type: none"> <li>• 802.11b, 1Mbps: -93.5dBm maximum</li> <li>• 802.11b, 11Mbps: -84dBm maximum</li> <li>• 802.11a/g, 6Mbps: -86dBm maximum</li> <li>• 802.11a/g, 54Mbps: -72dBm maximum</li> <li>• 802.11n, MCS07: -67dBm maximum</li> <li>• 802.11n, MCS15: -64dBm maximum</li> <li>• 802.11ac, MCS0: -84dBm maximum</li> <li>• 802.11ac, MCS9: -59dBm maximum</li> <li>• 802.11ax, MCS11(HT40): -59dBm maximum</li> <li>• 802.11ax, MCS11(VHT160): -58.5dBm maximum</li> </ul>
<b>Antenna type</b>	<p>High efficiency antenna with spatial diversity, mounted in the display enclosure</p> <p>Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications</p>
<b>Form Factor</b>	PCI-Express M.2 MiniCard with CNVi Interface
<b>Dimensions</b>	<p>1. Type 2230: 2.3 x 22.0 x 30.0 mm</p> <p>2. Type 1216: 1.67 x 12.0 x 16.0 mm</p>
<b>Weight</b>	<p>1. Type 2230: 2.8 g</p> <p>2. Type 126: 1.3 g</p>
<b>Operating Voltage</b>	3.3v +/- 9%
<b>Temperature</b>	<p><b>Operating</b> 14° to 158° F (-10° to 70° C)</p> <p><b>Non-operating</b> -40° to 176° F (-40° to 80° C)</p>
<b>Humidity</b>	<p><b>Operating</b> 10% to 90% (non-condensing)</p> <p><b>Non-operating</b> 5% to 95% (non-condensing)</p>
<b>Altitude</b>	<p><b>Operating</b> 0 to 10,000 ft (3,048 m)</p> <p><b>Non-operating</b> 0 to 50,000 ft (15,240 m)</p>
<b>LED Activity</b>	<p>LED Amber – Radio OFF</p> <p>LED Off – Radio ON</p>

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.
2. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
3. Check latest software/driver release for updates on supported security features.
4. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
5. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



### Technical Specifications

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Card Technology

<b>Bluetooth Specification</b>	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
<b>Frequency Band</b>	2402 to 2480 MHz
<b>Number of Available Channels</b>	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
<b>Signaling Data Rate</b>	Legacy: 3 Mbps signaling data rate <sup>6</sup> 2.17 Mbps BLE: 1 Mbps signaling data rate <sup>6</sup> 0.2 Mbps <a href="#">6. Actual throughput may vary.</a>
<b>Transmit Power</b>	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.



## Technical Specifications

<b>Realtek 802.11a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 5 Wireless Card<sup>1</sup></b>	<b>Wireless LAN Standards</b>	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	<b>Interoperability</b>	Wi-Fi certified modules
	<b>Frequency Band</b>	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
	<b>Data Rates</b>	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
	<b>Modulation</b>	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	<b>Security<sup>2</sup></b>	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • WAPI
	<b>Network Architecture Models</b>	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	<b>Roaming</b>	IEEE 802.11 compliant roaming between access points
	<b>Output Power<sup>3</sup></b>	• 802.11b : +14dBm minimum • 802.11g : +12dBm minimum • 802.11a : +12dBm minimum • 802.11n HT20(2.4GHz) : +12dBm minimum • 802.11n HT40(2.4GHz) : +12dBm minimum • 802.11n HT20(5GHz) : +10dBm minimum • 802.11n HT40(5GHz) : +10dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum
	<b>Power Consumption</b>	• Transmit mode: 2.0 W • Receive mode: 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode: 50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW
	<b>Power Management</b>	ACPI and PCI Express compliant power management



## Technical Specifications

<b>Receiver Sensitivity<sup>4</sup></b>	802.11 compliant power saving mode				
	<ul style="list-style-type: none"> <li>• 802.11b, 1Mbps: -93.5dBm maximum</li> <li>• 802.11b, 11Mbps: -84dBm maximum</li> <li>• 802.11a/g, 6Mbps: -86dBm maximum</li> <li>• 802.11a/g, 54Mbps: -72dBm maximum</li> <li>• 802.11n, MCS07: -67dBm maximum</li> <li>• 802.11n, MCS15: -64dBm maximum</li> <li>• 802.11ac, MCS0: -84dBm maximum</li> <li>• 802.11ac, MCS9: -59dBm maximum</li> </ul>				
<b>Antenna type</b>	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications				
<b>Form Factor</b>	PCI-Express M.2 MiniCard				
<b>Dimensions</b>	Type 2230 : 2.3 x 22.0 x 30.0 mm				
<b>Weight</b>	Type 2230 : 2.8g				
<b>Operating Voltage</b>	3.3v +/- 9%				
<b>Temperature</b>	<table> <tr> <td><b>Operating</b></td> <td>14° to 158° F (-10° to 70° C)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>-40° to 176° F (-40° to 80° C)</td> </tr> </table>	<b>Operating</b>	14° to 158° F (-10° to 70° C)	<b>Non-operating</b>	-40° to 176° F (-40° to 80° C)
<b>Operating</b>	14° to 158° F (-10° to 70° C)				
<b>Non-operating</b>	-40° to 176° F (-40° to 80° C)				
<b>Humidity</b>	<table> <tr> <td><b>Operating</b></td> <td>10% to 90% (non-condensing)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>5% to 95% (non-condensing)</td> </tr> </table>	<b>Operating</b>	10% to 90% (non-condensing)	<b>Non-operating</b>	5% to 95% (non-condensing)
<b>Operating</b>	10% to 90% (non-condensing)				
<b>Non-operating</b>	5% to 95% (non-condensing)				
<b>Altitude</b>	<table> <tr> <td><b>Operating</b></td> <td>0 to 10,000 ft (3,048 m)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>0 to 50,000 ft (15,240 m)</td> </tr> </table>	<b>Operating</b>	0 to 10,000 ft (3,048 m)	<b>Non-operating</b>	0 to 50,000 ft (15,240 m)
<b>Operating</b>	0 to 10,000 ft (3,048 m)				
<b>Non-operating</b>	0 to 50,000 ft (15,240 m)				
<b>LED Activity</b>	LED Amber – Radio OFF LED Off – Radio ON				

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
2. Check latest software/driver release for updates on supported security features.
3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Card Technology

<b>Bluetooth Specification</b>	4.0/4.1/4.2/5.0 Compliant
<b>Frequency Band</b>	2402 to 2480 MHz
<b>Number of Available Channels</b>	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
<b>Data Rates and Throughput</b>	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
<b>Transmit Power</b>	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.



## Technical Specifications

<b>Realtek RTL8822CE 802.11ac 2x2 Wi-Fi®+ Bluetooth® 5 Wireless Card</b> <sup>1</sup>	<b>Wireless LAN Standards</b>	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	<b>Interoperability</b>	Wi-Fi certified modules
	<b>Frequency Band</b>	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
	<b>Data Rates</b>	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
	<b>Modulation</b>	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	<b>Security</b> <sup>2</sup>	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • WAPI
	<b>Network Architecture Models</b>	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	<b>Roaming</b>	IEEE 802.11 compliant roaming between access points
	<b>Output Power</b> <sup>3</sup>	• 802.11b : +18.5dBm minimum • 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum • 802.11n HT20(2.4GHz) : +15.5dBm minimum • 802.11n HT40(2.4GHz) : +14.5dBm minimum • 802.11n HT20(5GHz) : +15.5dBm minimum • 802.11n HT40(5GHz) : +14.5dBm minimum • 802.11ac VHT80(5GHz) : +11.5dBm minimum
	<b>Power Consumption</b>	• Transmit mode: 2.0 W • Receive mode: 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode: 50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW
	<b>Power Management</b>	ACPI and PCI Express compliant power management



### Technical Specifications

<b>Receiver Sensitivity<sup>4</sup></b>	802.11 compliant power saving mode
	<ul style="list-style-type: none"> <li>• 802.11b, 1Mbps: -93.5dBm maximum</li> <li>• 802.11b, 11Mbps: -84dBm maximum</li> <li>• 802.11a/g, 6Mbps: -86dBm maximum</li> <li>• 802.11a/g, 54Mbps: -72dBm maximum</li> <li>• 802.11n, MCS07: -67dBm maximum</li> <li>• 802.11n, MCS15: -64dBm maximum</li> <li>• 802.11ac, MCS0: -84dBm maximum</li> <li>• 802.11ac, MCS9: -59dBm maximum</li> </ul>
<b>Antenna type</b>	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
<b>Form Factor</b>	PCI-Express M.2 MiniCard
<b>Dimensions</b>	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
<b>Weight</b>	1. Type 2230 : 2.8g 2. Type 126: 1.3g
<b>Operating Voltage</b>	3.3v +/- 9%
<b>Temperature</b>	<b>Operating</b> 14° to 158° F (-10° to 70° C) <b>Non-operating</b> -40° to 176° F (-40° to 80° C)
<b>Humidity</b>	<b>Operating</b> 10% to 90% (non-condensing) <b>Non-operating</b> 5% to 95% (non-condensing)
<b>Altitude</b>	<b>Operating</b> 0 to 10,000 ft (3,048 m) <b>Non-operating</b> 0 to 50,000 ft (15,240 m)
<b>LED Activity</b>	LED Amber – Radio OFF LED Off – Radio ON

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
2. Check latest software/driver release for updates on supported security features.
3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth® 4.0/4.1/4.2/5.0 Wireless Card Technology

<b>Bluetooth Specification</b>	4.0/4.1/4.2/5.0 Compliant
<b>Frequency Band</b>	2402 to 2480 MHz
<b>Number of Available Channels</b>	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
<b>Data Rates and Throughput</b>	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)



### Technical Specifications

**Transmit Power**

The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

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### Technical Specifications

#### POWER

<b>AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm New EM</b>	<b>Dimensions (H x W x D)</b>	102x55x30mm unit: 250g +/- 10g
	<b>Weight</b>	
	<b>Input</b>	<b>Input Efficiency</b> 88.0 % at 115 Vac and 89.0 % at 230Vac <b>Input frequency range</b> 47 ~ 63 Hz <b>Input AC current</b> Max. 1.7 A at 90 Vac
	<b>Output</b>	<b>Output power</b> 65W <b>DC output</b> 19.5V <b>Hold-up time</b> 5ms at 115 Vac input <b>Output current limit</b> <11.0A
	<b>Connector</b>	C6 (3pin/with grounded, with Smart ID DC connector)
	<b>Environmental Design</b>	<b>Operating temperature</b> 32°F to 95°F (0° to 35°C) <b>Non-operating (storage) temperature</b> -4°F to 185°F (-20° to 85°C) <b>Altitude</b> 0 to 16,400 ft (0 to 5,000 m) <b>Humidity</b> 20% to 95% <b>Storage Humidity</b> 10% to 95%
	<b>EMI and Safety Certifications</b>	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

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<b>AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m</b>	<b>Dimensions</b>	95 x 40 x 26.8 mm
	<b>Weight</b>	200 g +/- 10 g
	<b>Input</b>	<b>Input Efficiency</b> 87.74 % at 115 Vac and 88.4 % at 230Vac <b>Input frequency range</b> 47 ~ 63 Hz <b>Input AC current</b> Max. 1.4 A at 90 Vac
	<b>Output</b>	<b>Output power</b> 45 W <b>DC output</b> 19.5 V <b>Hold-up time</b> 5 ms at 115 Vac input <b>Output current limit</b> <8.0A
	<b>Connector</b>	C6 (3pin/with grounded, with Smart ID DC connector)
	<b>Environmental Design</b>	<b>Operating temperature</b> 32°F to 95°F (0° to 35°C) <b>Non-operating (storage) temperature</b> -4°F to 185°F (-20° to 85°C) <b>Altitude</b> 0 to 16,400 ft (0 to 5000m) <b>Humidity</b> 20% to 95%



### Technical Specifications

	<b>Storage Humidity</b>	10% to 95%
<b>EMI and Safety Certifications</b>	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.	

<b>HP 3-cell Long Life Li-Ion (41 Wh)</b>	<b>Dimensions (H x W x L)</b>	6.0. x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)
	<b>Weight</b>	0.175 kg (0.37 lb)
	<b>Cells/Type</b>	3 cell Lithium-Ion Polymer cell / 515974
	<b>Energy</b>	
	<b>Voltage</b>	11.4 V / 11.34 V
	<b>Amp-hour capacity</b>	3.6 Ah / 3.62 Ah
	<b>Watt-hour capacity</b>	41 Wh
	<b>Temperature</b>	
	<b>Operating (Charging)</b>	32° to 113° F (0° to 45° C)
	<b>Operating (Discharging)</b>	14° to 122° F (-10° to 60° C)
	<b>Fuel Gauge LED</b>	NA
	<b>Warranty</b>	1-year
	<b>Optional Travel Battery Available</b>	No

<b>HP 4-cell Long Life Li-Ion (46 Wh)</b>	<b>Dimensions (H x W x L)</b>	7.51. x 186.85 x 90.2 mm (0.295 x 7.35 x 3.55 inch)
	<b>Weight</b>	0.20 kg (0.44 lb)
	<b>Cells/Type</b>	4 cell Lithium-Ion Polymer cell / 336975
	<b>Energy</b>	
	<b>Voltage</b>	15.4 V
	<b>Amp-hour capacity</b>	2.988 Ah
	<b>Watt-hour capacity</b>	46 Wh
	<b>Temperature</b>	
	<b>Operating (Charging)</b>	32° to 113° F (0° to 45° C)
	<b>Operating (Discharging)</b>	14° to 122° F (-10° to 60° C)
	<b>Fuel Gauge LED</b>	NA
	<b>Warranty</b>	1-year
	<b>Optional Travel Battery Available</b>	No



### Technical Specifications

#### ENVIRONMENTAL DATA

<b>Eco-Label Certifications &amp; declarations</b>	<p>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:</p> <ul style="list-style-type: none"> <li>• IT ECO declaration</li> <li>• US ENERGY STAR®</li> <li>• US Federal Energy Management Program (FEMP)</li> <li>• EPEAT® registered where applicable. EPEAT® registration varies by country. See <a href="http://www.epeat.net">www.epeat.net</a> for registration status by country.* *Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit <a href="http://www.epeat.net">www.epeat.net</a> for more information.</li> <li>• TCO -N/A</li> <li>• China Energy Conservation Program (CECP)</li> <li>• China State Environmental Protection Administration (SEPA)</li> <li>• Taiwan Green Mark</li> <li>• Korea Eco-label</li> <li>• Japan PC Green label*</li> </ul>		
<b>Sustainable Impact Specifications</b>	<ul style="list-style-type: none"> <li>• 2% post-consumer recycled plastic</li> <li>• External Power Supply 90% Efficiency</li> <li>• Low halogen</li> <li>• Outside Box and corrugated cushions are 100% sustainably sourced and recyclable</li> <li>• Recycled Plastic cushions</li> <li>• Bulk packaging available</li> </ul>		
<b>System Configuration</b>	<p>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.</p>		
<b>Energy Consumption (in accordance with US ENERGY STAR® test method)</b>	<b>115VAC, 60Hz</b>	<b>230VAC, 50Hz</b>	<b>100VAC, 50Hz</b>
Normal Operation (Sort idle)	4.26 W	4.37 W	4.29 W
Normal Operation (Long idle)	1.84 W	1.65 W	1.38 W
Sleep	0.36 W	0.37 W	0.36 W
Off	0.19 W	0.21 W	0.19 W
	<p><b>NOTE:</b> Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.</p>		
<b>Heat Dissipation*</b>	<b>115VAC, 60Hz</b>	<b>230VAC, 50Hz</b>	<b>100VAC, 50Hz</b>
Normal Operation (Short idle)	15 BTU/hr	15 BTU/hr	15 BTU/hr
Normal Operation (Long idle)	6 BTU/hr	6 BTU/hr	6 BTU/hr
Sleep	1 BTU/hr	1 BTU/hr	1 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr



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	* <b>NOTE:</b> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
<b>Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)</b>	Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)	
Typically Configured – Idle	2.4	19	
Fixed Disk – Random writes	1.8	19	
Optical Drive – Sequential reads	3.5	35	
<b>Longevity and Upgrading</b>	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the spare parts are available throughout the warranty period and or for up to “5” years after the end of production.		
<b>Additional Information</b>	<ul style="list-style-type: none"> <li>• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>• This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> <li>• This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>• This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see <a href="http://www.epeat.net">http://www.epeat.net</a></li> <li>• Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> </ul>		
<b>Packaging Materials</b>	<b>External:</b>	PAPER/Corrugated	256 g
	<b>Internal:</b>	PLASTIC/EPE (Expanded Polyethylene)	44 g
		PLASTIC/Polyethylene low density	13 g
		PLASTIC/polypropylene	3 g
	The plastic packaging material contains at least 80% recycled content.		
	The corrugated paper packaging materials contains at least 35% recycled content.		
<b>RoHS Compliance</b>	<p>HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.</p> <p>We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.</p> <p>We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.</p> <p>To obtain a copy of the HP RoHS Compliance Statement, see <a href="#">Error! Hyperlink reference not valid. HP RoHS position statement.</a></p>		
<b>Material Usage</b>	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html">http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html</a> ):		



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	<ul style="list-style-type: none"> <li>• Asbestos</li> <li>• Certain Azo Colorants</li> <li>• Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>• Cadmium</li> <li>• Chlorinated Hydrocarbons</li> <li>• Chlorinated Paraffins</li> <li>• Bis(2-Ethylhexyl) phthalate (DEHP)</li> <li>• Benzyl butyl phthalate (BBP)</li> <li>• Dibutyl phthalate (DBP)</li> <li>• Diisobutyl phthalate (DIBP)</li> <li>• Formaldehyde</li> <li>• Halogenated Diphenyl Methanes</li> <li>• Lead carbonates and sulfates</li> <li>• Lead and Lead compounds</li> <li>• Mercuric Oxide Batteries</li> <li>• Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>• Ozone Depleting Substances</li> <li>• Polybrominated Biphenyls (PBBs)</li> <li>• Polybrominated Biphenyl Ethers (PBBEs)</li> <li>• Polybrominated Biphenyl Oxides (PBBOs)</li> <li>• Polychlorinated Biphenyl (PCB)</li> <li>• Polychlorinated Terphenyls (PCT)</li> <li>• Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> <li>• Radioactive Substances</li> <li>• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
<p><b>Packaging Usage</b></p>	<p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> <li>• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>• Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>• Design packaging materials for ease of disassembly.</li> <li>• Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>• Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>• Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
<p><b>End-of-life Management and Recycling</b></p>	<p>HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>



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<p><b>HP, Inc. Corporate Environmental Information</b></p>	<p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report  <a href="http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html">http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</a></p> <p>Eco-label certifications  <a href="http://www8.hp.com/us/en/hp-information/environment/ecolabels.html">http://www8.hp.com/us/en/hp-information/environment/ecolabels.html</a></p> <p>ISO 14001 certificates:  <a href="http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842">http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842</a>                      and  <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf">http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</a></p>
<p><b>footnotes</b></p>	<ul style="list-style-type: none"> <li>• Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>• External power supplies, WWAN modules, power cords, cables and peripherals excluded.</li> <li>• 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> <li>• Plastic cushions are made from &gt;90% recycled plastic.</li> </ul>

### Technical Specifications

#### **COUNTRY OF ORIGIN**

China

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### Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part Number
<b>Cases</b>	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
	HP Prelude Top Load 15.6	1E7D7AA
	HP Prelude Backpack 15.6	1E7D6AA
<b>Docking</b>	HP 4.5 mm and USB-C® Dock Adapter G2	6LX61AA
<b>Input/Output</b>	HP USB Essential Keyboard/Mouse	H6L29AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Slim Wireless Keyboard & Mouse	T6L04AA
	HP Wired Desktop 320K Keyboard	9SR37AA
	HP Slim Wireless Keyboard (Link-5)	T6U20AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Essential USB Mouse	2TX37AA
	HP USB Travel Mouse	G1K28AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP HDMI to VGA Adapter	H4F02AA
HP HDMI to DVI	F5A28AA	
<b>Power</b>	HP 45W Smart AC Adapter	H6Y88AA
	HP 65W Smart AC Adapter	H6Y89AA
	HP 65W Slim Adapters (w/ detachable DC cable + TIPS)	H6Y82AA
<b>Storage</b>	HP External USB Optical Drive	F2B56AA



### Summary of Changes

<b>Date of change:</b>	<b>Version History:</b>		<b>Description of change:</b>
November 4, 2020	V1 to V2	Updated	Removed - Intel® Iris® X <sup>e</sup> Graphics from processor name and added Iris footnote in graphics section
December 14, 2020	V2 to V3	Updated	USB Information
February 12, 2021	V3 to V4	Updated	Processors and added Battery Specs
February 25, 2021	V4 to V5	Updated	Xerox DocuShare offer value
April 20, 2021	V5 to V6	Updated	TechSpecs/Memory Modules
May 6, 2021	V6 to V7	Added	HP Smart Support
June 10, 2021	V7 to V8	Updated	Security lock slot in Overview section
June 22, 2021	V8 to V9	Added	Environmental Data
July 6, 2021	V9 to V10	Added	Battery disclaimer
October 7, 2021	V10 to V11	Updated	Operating system section
October 11, 2021	V11 to V12	Updated	Windows 10 with Free upgrade to Windows 11 when available in OS section and footnote. Removed Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)
October 15, 2021	V12 to V13	Removed	Memory from Options and Accessories section
October 21, 2021	V13 to V14	Added	Processor section
November 2, 2021	V14 to V15	Updated	At a Glance section
December 13, 2021	V15 to V16	Updated	OS footnotes and Wi-Fi 6 footnotes
March 21, 2022	V16 to V17	Updated	Environmental Data
April 4, 2022	V17 to V18	Added	Memory Slot section and footnote
April 26, 2022	V18 to V19	Added	Dual Storage footnote
July 21, 2022	V19 to V20	Removed	HP USB-C®/A Universal Dock G2 from Docking Options
August 8, 2022	V20 to V21	Updated	Memory Slots
March 6, 2023	V21 to V22	Updated	Storage and Drives section
March 13, 2023	V22 to V23	Updated	Bluetooth in Networking and Communication section
March 22, 2023	V23 to V24	Updated	USB Type C® description
	V24 to V25		

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